Si2318CDS

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RoHS

COMPLIANT

HALOGEN

FREE

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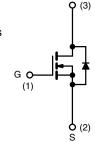
N-Channel 40 V (D-S) MOSFET

FEATURES

- TrenchFET[®] power MOSFET
- 100 % R_g tested
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- DC/DC converters
- Load switch
- Portable and consumer applications



N-Channel MOSFET

Marking code: P9

PRODUCT SUMMARY					
V _{DS} (V)	40				
$R_{DS(on)}$ max. (Ω) at V_{GS} = 10 V	0.042				
$R_{DS(on)}$ max. (Ω) at V_{GS} = 4.5 V	0.051				
Q _g typ. (nC)	2.9				
I _D (A) ^a	5.6				
Configuration	Single				

ORDERING INFORMATION	
Backage	SOT 22

Package	SOT-23
Lead (Pb)-free and halogen-free	Si2318CDS-T1-GE3

PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	40		
Gate-source voltage		V _{GS}	± 20	V	
	T _C = 25 °C		5.6 ^a		
	T _C = 70 °C		4.5		
Continuous drain current ($T_J = 150 \ ^\circ C$)	T _A = 25 °C	I _D	4.3 ^{b, c}		
	T _A = 70 °C		3.5 ^{b, c}	А	
Pulsed drain current		I _{DM}	20		
Continuous source-drain diode current	T _C = 25 °C		1.75		
	T _A = 25 °C	I _S	1.04 ^{b, c}		
	T _C = 25 °C		2.1		
	T _C = 70 °C		1.3		
Maximum power dissipation	T _A = 25 °C	P _D	1.25 ^{b, c}	W	
	T _A = 70 °C	1	0.8 ^{b, c}		
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	*0	
Soldering recommendations (peak temperature)		Ť	260	°C	

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum junction-to-ambient b, d	t ≤ 5 s	R _{thJA}	80	100	°C/W	
Maximum junction-to-foot (drain)	Steady state	R _{thJF}	40	60	0/10	

Notes

a. Based on T_C = 25 $^\circ C$

b. Surface mounted on 1" x 1" FR4 board

c. t = 5 s

d. Maximum under steady state conditions is 125 °C/W

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static			•		•	•	
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 V$, $I_D = 250 \mu A$	40	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$		-	39	-		
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA	-	-4.7	-	mV/°C	
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	1.2	-	2.5	V	
Gate-source leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$	-	-	± 100	nA	
		$V_{DS} = 40 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	1	μΑ	
Zero gate voltage drain current	IDSS	V_{DS} = 40 V, V_{GS} = 0 V, T_J = 70 °C	-	-	10		
On-state drain current ^a	I _{D(on)}	$V_{DS} \le 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	20	-	-	А	
	_	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 4.3 \text{ A}$	-	0.035	0.042		
Drain-source on-state resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 3.9 \text{ A}$	-	0.041	0.051	Ω	
Forward transconductance ^a	9 _{fs}	$V_{DS} = 20 \text{ V}, \text{ I}_{D} = 4.3 \text{ A}$	-	17	-	S	
Dynamic ^b			•		•	•	
Input capacitance	C _{iss}		-	340	-		
Output capacitance	C _{oss}	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	60	-	pF	
Reverse transfer capacitance	C _{rss}		-	30	-		
Total gate charge	Q _g	$V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 4.3 \text{ A}$	-	5.8	9		
			-	2.9	6	nC	
Gate-source charge	Q _{qs}	$V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 4.3 \text{ A}$	-	1.1	-		
Gate-drain charge	Q _{qd}		-	0.9	-		
Gate resistance	R _g	f = 1 MHz	0.6	3.3	6.6	Ω	
Turn-on delay time	t _{d(on)}		-	12	20	-	
Rise time	tr	$V_{DD} = 20 V, R_1 = 5.7 \Omega$	-	50	75		
Turn-off delay time	t _{d(off)}	$I_{D}\cong \textbf{3.5}~A,V_{GEN}=\textbf{4.5}~V,R_{g}=\textbf{1}~\Omega$	-	10	20		
Fall time	t _f		-	8	16	1	
Turn-on delay time	t _{d(on)}		-	7	14	- ns - -	
Rise time	t _r	$V_{DD} = 20 \text{ V}, \text{ R}_{L} = 5.7 \Omega$	-	20	30		
Turn-off delay time	t _{d(off)}	$I_D \cong 3.5 \text{ A}, V_{\text{GEN}} = 10 \text{V}, \text{R}_\text{g} = 1 \Omega$	-	14	21		
Fall time	t _f		-	8	16		
Drain-Source Body Diode Characterist	ics		•		•	•	
Continuous source-drain diode current	ا _S	T _C = 25 °C	-	-	1.75		
Pulse diode forward current	I _{SM}		-	-	20	A	
Body diode voltage	V _{SD}	I _S = 3.5 A, V _{GS} = 0 V	-	0.85	1.2	V	
Body diode reverse recovery time	t _{rr}		-	15	23	ns	
Body diode reverse recovery charge	Q _{rr}	I _F = 3.5 A, di/dt = 100 A/μs,	-	7	14	nC	
Reverse recovery fall time	ta	$T_J = 25 \text{ °C}$	-	11	-	-	
Reverse recovery rise time	t _b		-	4	<u> </u>	ns	

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

b. Guaranteed by design, not subject to production testing

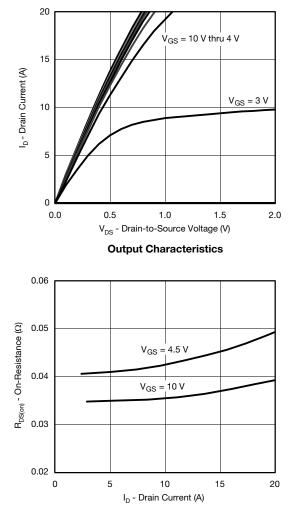
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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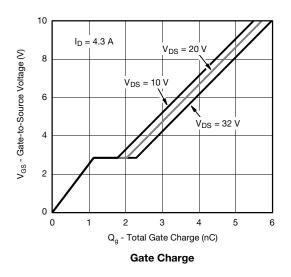


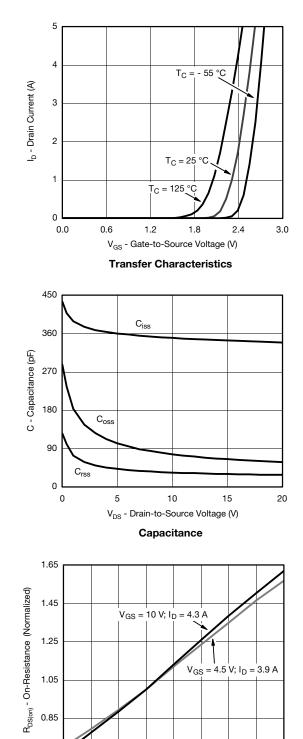
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



On-Resistance vs. Drain Current and Gate Voltage





0.65 - 50 - 25 0 25 50 75 100 125 150 T_J - Junction Temperature (°C)

On-Resistance vs. Junction Temperature

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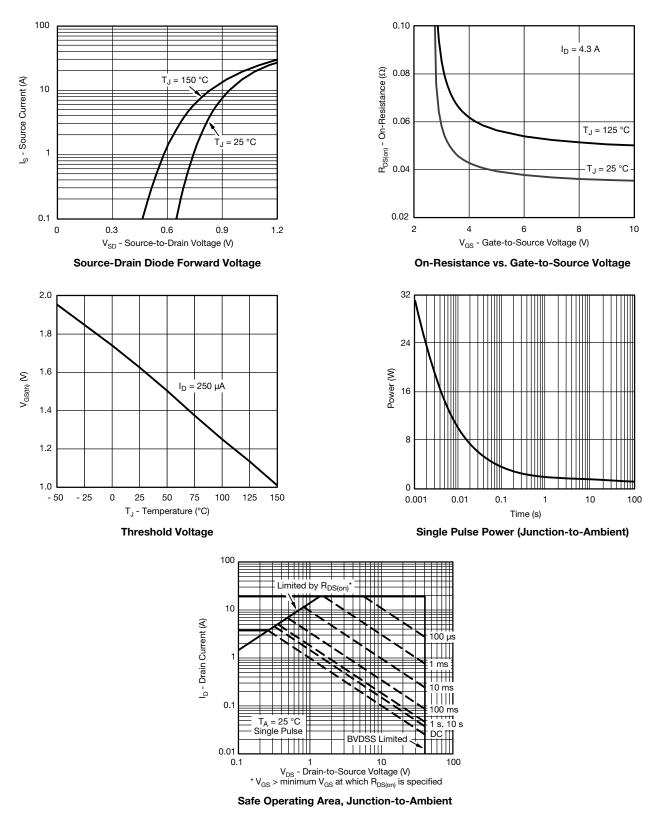
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



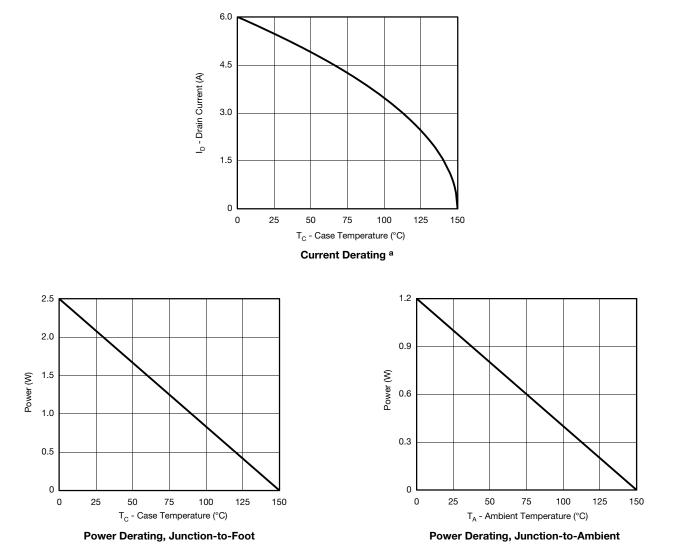
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Note

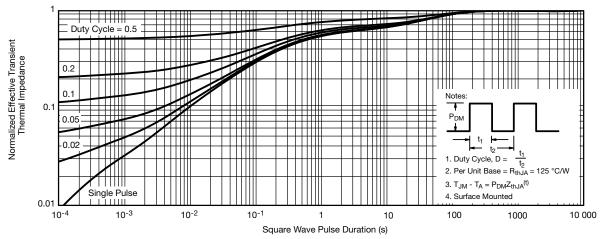
a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit



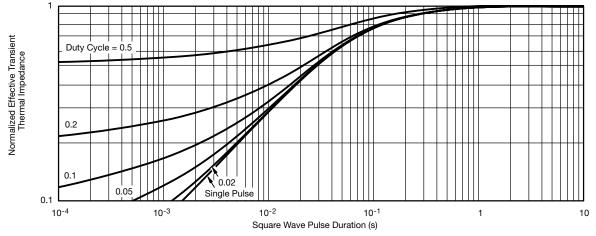
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)







Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?67030.

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Package Information

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SOT-23 (TO-236): 3-LEAD







Dim	MILLIN	METERS	INCHES		
	Min	Max	Min	Мах	
Α	0.89	1.12	0.035	0.044	
A ₁	0.01	0.10	0.0004	0.004	
A ₂	0.88	1.02	0.0346	0.040	
b	0.35	0.50	0.014	0.020	
С	0.085	0.18	0.003	0.007	
D	2.80	3.04	0.110	0.120	
E	2.10	2.64	0.083	0.104	
E ₁	1.20	1.40	0.047	0.055	
е	0.95 BSC		0.0374 Ref		
e ₁	1.90 BSC		0.0748 Ref		
L	0.40	0.60	0.016	0.024	
L ₁	0.6	4 Ref	0.025 Ref		
S	0.50 Ref		0.020 Ref		
q	3°	8°	3°	8°	



Application Note 826

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RECOMMENDED MINIMUM PADS FOR SOT-23



Recommended Minimum Pads Dimensions in Inches/(mm)

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